CONMHF1-SMD-G-T <

TE Internal #: CONMHF1-SMD-G-T UMCC RF Interface, Jack, 50 Ω, Snap-On, 6 GHz Operating Frequency, Cable-to-Board, 1 Position, Printed Circuit Board, Board Mount, Copper Alloy, Gold

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Connectors > RF Connectors > Coax Connectors



RF Interface: UMCC RF Connector Style: Jack Impedance: 50 Ω RF Connector Coupling Mechanism: Snap-On Operating Frequency: 6 GHz

Features

Product Type Features

Connector Product Type	Connector Assembly
RF Interface	UMCC
RF Connector Style	Jack

Connector System	Cable-to-Board
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Number of Positions	1
Number of Coaxial Contacts	1
Electrical Characteristics	
Impedance	50 Ω
Body Features	
Body Material	Copper Alloy
Body Plating Material	Gold
Mechanical Attachment	
RF Connector Coupling Mechanism	Snap-On
Connector Mounting Type	Board Mount

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Operation/Application

Operating Frequency	6 GHz
Circuit Application	Signal
Other	
Dielectric Material	LCP

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant with Exemptions
EU ELV Directive 2000/53/EC	Not Yet Reviewed
China RoHS 2 Directive MIIT Order No 32, 2016	Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Not Yet Reviewed
Halogen Content	Not Yet Reviewed for halogen content
Solder Process Capability	Not reviewed for solder process capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge

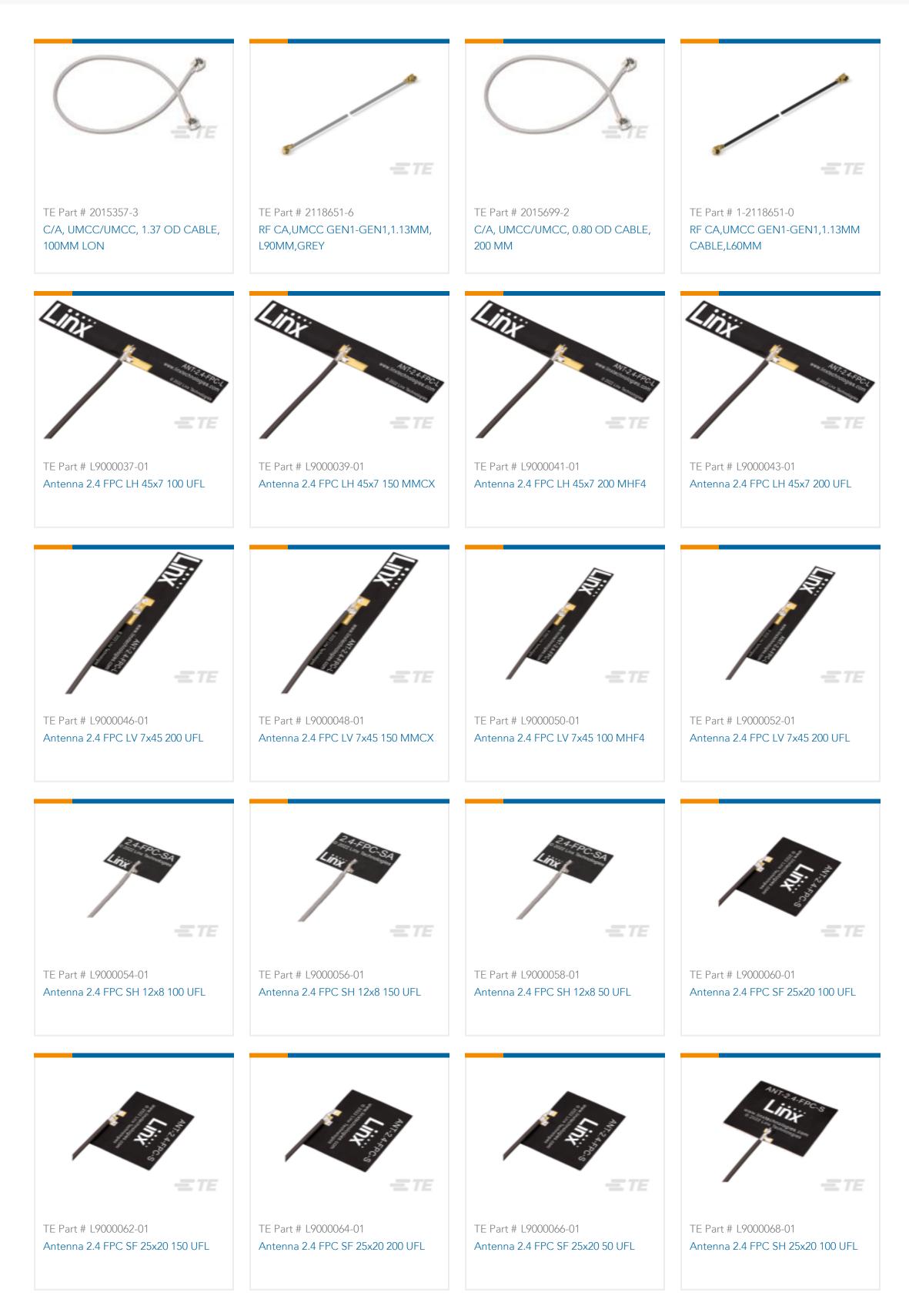
based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked.Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulations, TE's information on SVHC in articles for this part number is still based on the European Chemical Agency (ECHA) 'Guidance on requirements for substances in articles' (Version: 2, April 2011), applying the 0.1% weight on weight concentration threshold at the finished product level. TE is aware of the European Court of Justice ruling of September 10th, 2015 also known as O5A (Once An Article Always An Article) stating that, in case of 'complex object', the threshold for a SVHC must be applied to both the product as a whole and simultaneously to each of the articles forming part of its composition. TE has evaluated this ruling based on the new ECHA "Guidance on requirements for substances in articles" (June 2017, version 4.0) and will be updating its statements accordingly.

Compatible Parts

CONMHF1-SMD-G-T

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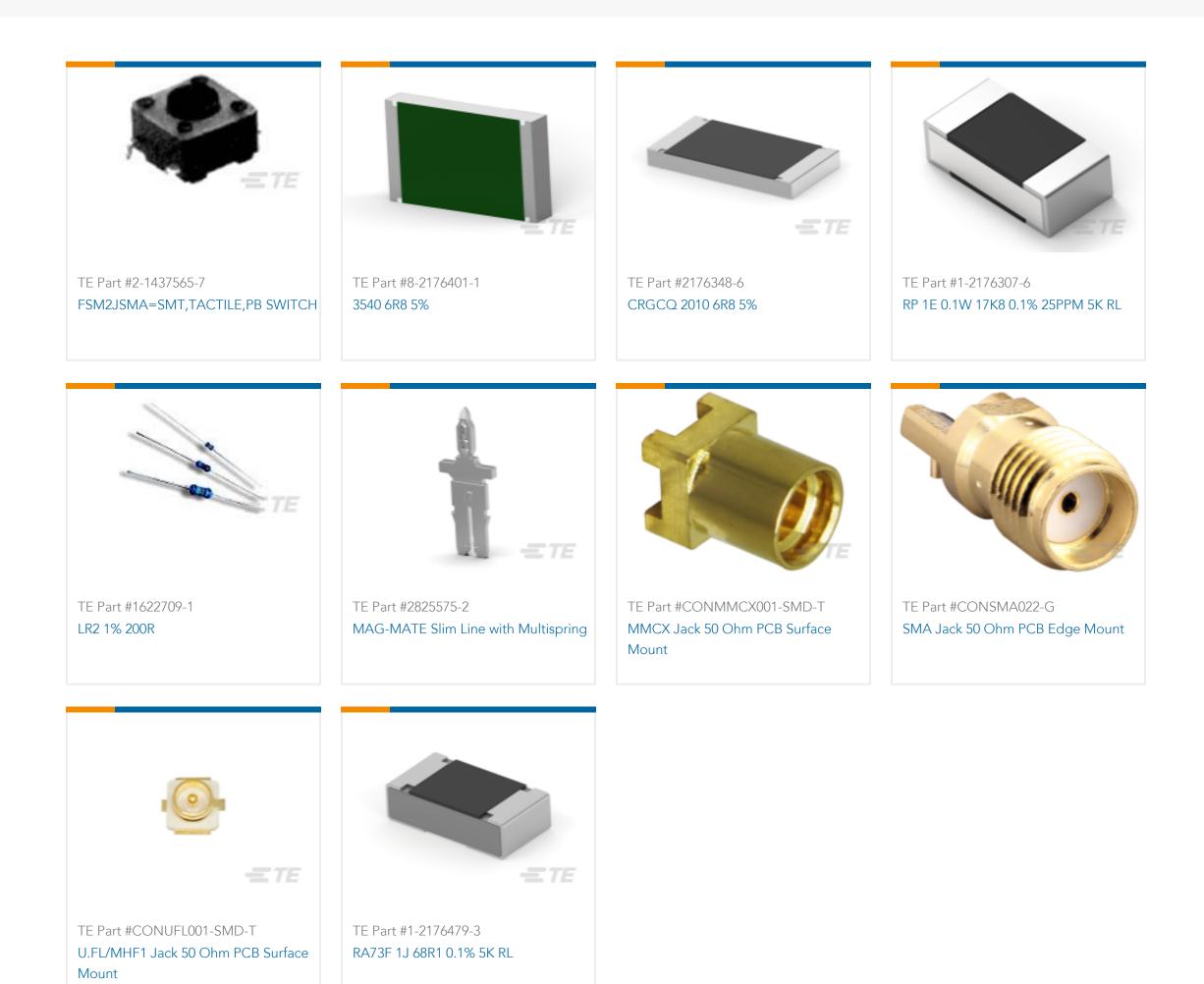


Customers Also Bought

CONMHF1-SMD-G-T

UMCC RF Interface, Jack, 50 Ω, Snap-On, 6 GHz Operating Frequency, Cable-to-Board, 1 Position, Printed Circuit Board, Board Mount, Copper Alloy, Gold





Documents

Product Drawings U.FL/MHF1 Jack 50 Ohm PCB Surface Mount

English

Datasheets & Catalog Pages U.FL-Type Jack PCB Surface-Mount Connector

English